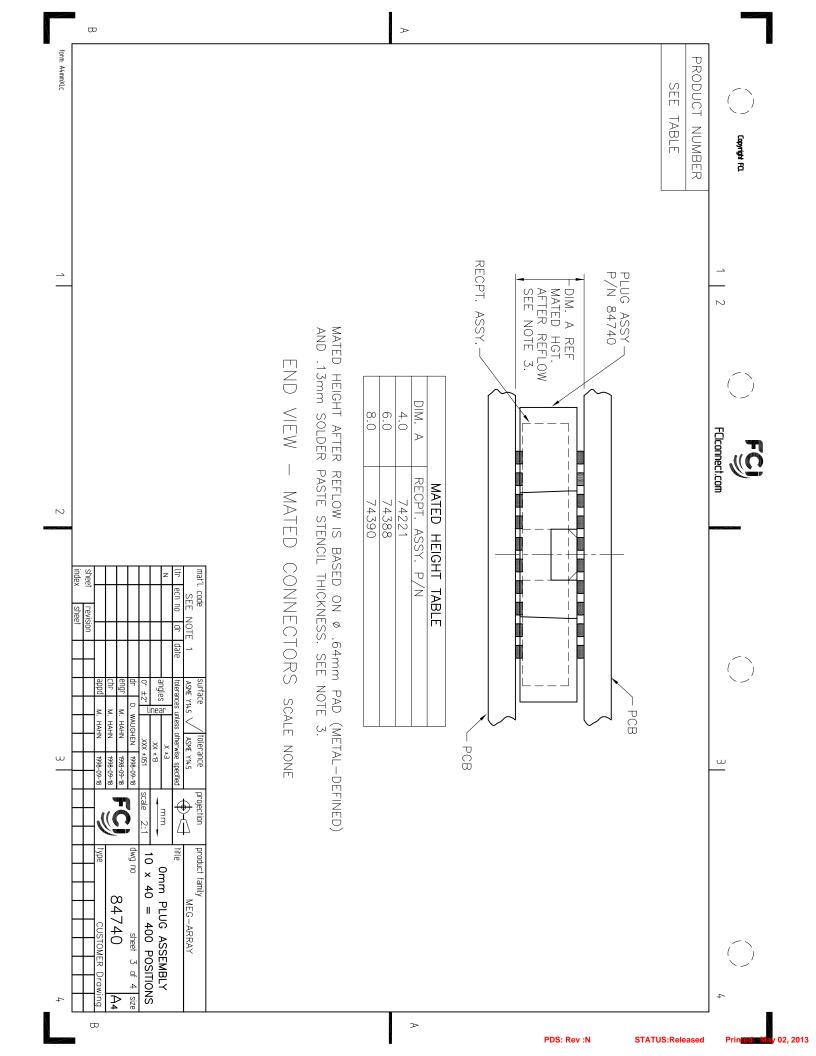


STATUS:Released



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4, 7 AND 8	SnAgCu LEAD FREE	SPECIAL	YES	-84740-502LF
4 AND 8	SnPb	SPECIAL	YES	-84740-502
7 AND 8	SnAgCu LEAD FREE	30μ" (.76μm) Au SPECIAL	S∃X	-84740-402LF
œ	SnPb	30µ" (.76µm) Au SPECIAL	SHA	84740 402
7 AND 8	SmAgCu LEAD FREE	15µ" (.38µm) Au SPECIAL	YES	-84740-302LF
Φ	SnPb	15µ" (.38µm) Au SPECIAL	YES	-84740-302
7 AND 8	SnAgCu LEAD FREE	SPECIAL	YES	84740-A02LF
00	SnPb	SPECIAL	YES	84740-A02
4 AND 7	SnAgCu LEAD FREE	GXT SPECIAL	YES	84740-292LF
4	SnPb	GXT SPECIAL	YES	84740-292
4 AND 7	SnAgCu LEAD FREE	Au SPECIAL	YES	84740-202LF
4	SnPb	Au SPECIAL	YES	84740-202
7	SnAgCu LEAD FREE	30µ" (.76µm) GXT	YES	84740-192LF
	SnPb	30µ" (.76µm) GXT	YES	84740-192
7	SnAgCu LEAD FREE	30µ" (.76µm) Au	YES	84740-102LF
	SnPb	30µ" (.76µm) Au	YES	84740-102
7	SnAgCu LEAD FREE	15µ" (.38µm) GXT	S3A	84740-092LF
	SnPb	15µ" (.38µm) GXT	YES	84740-092
7	SnAgCu LEAD FREE	15μ" (.38μm) Au	YES	84740-002LF
	SnPb	15µ" (.38µm) Au	Sak	84740-002
NOTES	SOLDER BALL	CONTACT PLATING, SEE NOTE 10	PICK—UP CAP	PRODUCT NUMBER

NOTES:

(1.) MATERIAL:

HOUSING: LCP CONTACT: COPPER ALLOY

PLATING:

SOLDER BALL: (SEE TABLE), EITHER EUTECTIC SnPb OR LEAD FREE OR 95.5Sn/4Ag/0.5Cu CONTACT: (SEE TABLE AND OTHER NOTES)

- (2.)SOLDER BALLS WILL NOT BE PERFECT SPHERICAL SHAPE DUE TO REFLOW ATTACHMENT.
- $\overline{(3.)}$ Mated height effected by customer's PCB PAD size, plating SOLDER REFLOW PROFILE, & SOLDER PASTE.
- (4.)PLATING FOR INDICATED -2XX SERIES PART NOS. IS AU OVER NI WITH SPECIAL CONTACT ENVIRONMENT (25 LIFE EXPECTANCY) GEOMETRY TO MEET REQUIREMENTS OF TELCORDIA GR-1217-CORE: CENTRAL OFFICE
- 5.)-302, -302LF, -402, -402LF, -502, -502LF ARE OBSOLETE
- (6.)FOR PROPER APPLICATION FOLLOW FCI APPLICATION SPECIFICATION GS-20-033. TO A HIGHER REFLOW TEMPERATURE. LEAD FREE PRODUCT IS THEREFORE NOT BACKWARDS WITH LEADED OR SOME SOLDERING APPLICATIONS.

- (7.) THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-47-0004 PRODUCT MEETING THIS DIRECTIVE IS IDENTIFIED IN THE LOT CODE NUMBER MARKED ON EACH PART BY HAVING AN "X"  $^{\circ}$ IN THE SEVENTH CHARACTER POSITION.
- (8.)84740-A02, -A02LF, ARE CUSTOMER SPECIALS
- (9) CURRENT COMPANY LOGO TO BE VISIBLE IN APPROXIMATE AREA SHOWN.
- 10. FOR PURPOSES OF MAXIMIZING MANUFACTURING UTILIZATION, PLATED TERMINALS WITH HIGHER PLATING THICKNESS THAN THE REQUIRED AMOUNT, MAY BE SUBSTITUTED FOR TERMINALS WITH THE REQUIRED PLATING.
- 11. PLUG TERMINALS MAY OR MAYNOT INCLUDE ANTI-WICKING SLOT FEATURE THAT IS TYPICALLY ASSOCIATED WITH HIGHER PLATING THICKNESS OPTIONS.

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PDS: Rev :N

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